

STS25NH3LL

N-channel 30 V - 0.0032 Ω - 25 A - SO-8 STripFET™ III Power MOSFET for DC/DC conversion

Features

Туре	V _{DSS}	R _{DS(on)}	I _D
STS25NH3LL	30 V	<0.0035 Ω	25 A ⁽¹⁾

- 1. This value is rated according to Rthj-pcb
- Optimal R_{DS(on)} x Qg trade off @ 4.5 V
- Conduction losses reduced
- Switching losses reduced

Applications

■ Switching applications

Description

This device utilizes the advanced design rules of ST's proprietary STripFET™ technology. The innovative process coupled with unique metallization techniques makes it possible to produce the most advanced low voltage Power MOSFET in an SO-8 package. The device is therefore suitable for demanding DC-DC converter applications where high efficiency at high output current is needed.

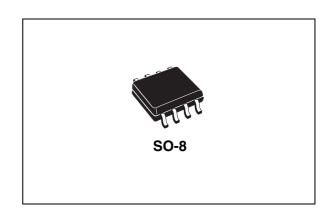


Figure 1. Internal schematic diagram

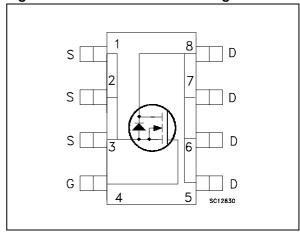


Table 1. Device summary

Order code	Marking	Package	Packaging
STS25NH3LL	25H3LL	SO-8	Tape & reel

Electrical ratings STS25NH3LL

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{GS}	Gate-source voltage	± 18	٧
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	25	Α
I _D	Drain current (continuous) at T _C =100 °C	18	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	100	Α
P _{TOT} (1)	Total dissipation at T _C = 25 °C	3.2	W

^{1.} This value is rated according to Rthj-pcb

Table 3. Thermal data

	Symbol	Parameter	Value	Unit
ĺ	R _{thj-pcb} (1)	Thermal resistance junction-amb max	47	°C/W
	T _j T _{stg}	Operation junction temperature Storage temperature	-55 to 175	ů

^{1.} When mounted on FR-4 board of 1 inch2, 2 oz Cu, t< 10 sec

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AV}	Not-repetitive avalanche current (pulse width limited by Tj max.)	12.5	Α
E _{AS}	Single pulse avalanche energy (starting Tj = 25 °C, $I_D = I_{AV}$, $V_{DD} = 24 \text{ V}$)	1.3	J

^{2.} Pulse width limited by safe operating area

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating, V_{DS} = Max rating @125 °C			1 10	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 18 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 10 V, I_{D} = 12.5 A V_{GS} = 4.5 V, I_{D} = 12.5 A		0.0032 0.004	0.0035 0.005	Ω Ω

Table 6. Dynamic

	- ,					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} = 10 \text{ V}, I_D = 12.5 \text{ A}$		30		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25 V, f = 1 MHz, V _{GS} = 0		4450 655 50		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 15 \text{ V}, I_{D} = 25 \text{ A}$ $V_{GS} = 4.5 \text{ V}$ Figure 14		30 12.5 10	40	nC nC nC
Q _{OSS} (2)	Output charge	V _{DD} = 24 V, V _{GS} = 0		23		nC
R _G	Gate input resistance	f = 1 MHz, gate DC bias =0 test signal level = 20 mV open drain	1	2	3	Ω

^{1.} Pulsed: pulse duration=300 μs, duty cycle 1.5%

^{2.} $Q_{OSS} = C_{oss} * \Delta V_{in}, C_{oss} = C_{gd} + C_{ds}$

Electrical characteristics STS25NH3LL

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} = 15 V, I_{D} = 12.5 A, R_{G} = 4.7 Ω , V_{GS} = 10 V Figure 13		18 50 75 8		ns ns ns ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				25	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				100	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 25 A, V _{GS} = 0			1.3	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 25 A, di/dt = 100 A/µs, V_{DD} = 25 V, T_{J} = 150 °C Figure 18		32 34 2.1		ns nC A

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration=300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

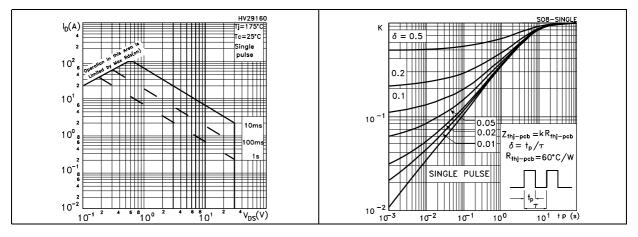


Figure 4. Output characteristics

Figure 5. Transfer characteristics

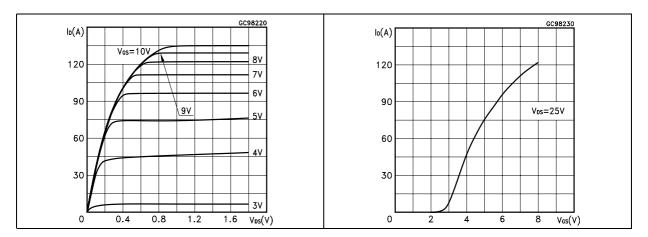
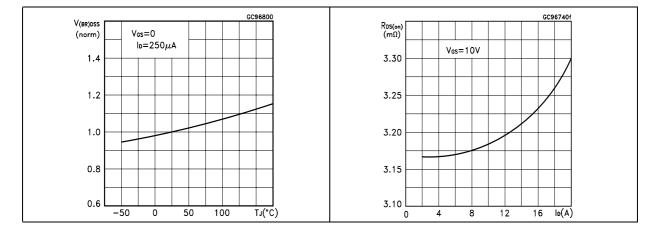


Figure 6. Normalized B_{VDSS} vs temperature

Figure 7. Static drain-source on resistance



Electrical characteristics STS25NH3LL

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

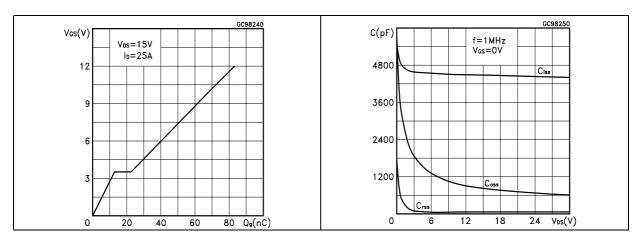


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on resistance vs temperature

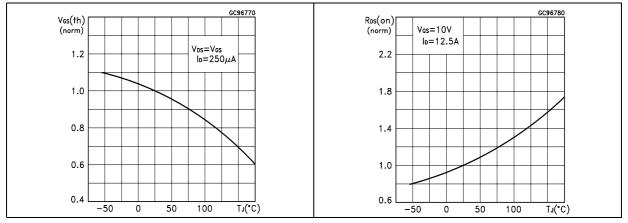
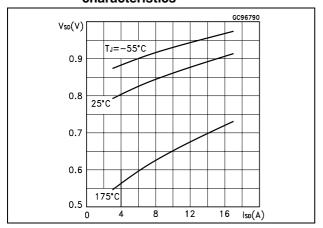


Figure 12. Source-drain diode forward characteristics



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STS25NH3LL Test circuit

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

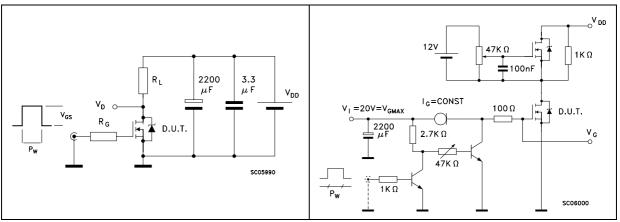


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

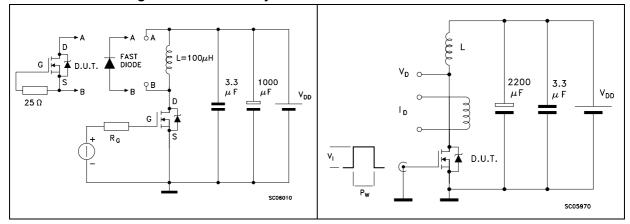
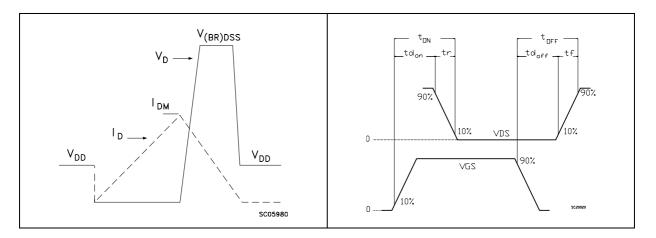


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform

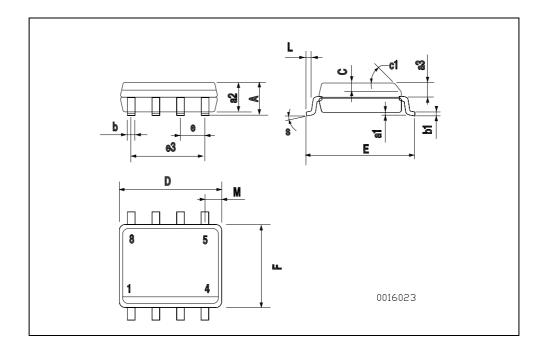


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

SO-8 MECHANICAL DATA

DIM.		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45 (typ.)		•
D	4.8		5.0	0.188		0.196
Е	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S			8 (n	nax.)	•	•



Revision history STS25NH3LL

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
19-Nov-2007	10	Document status promoted from preliminary data to datasheet

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